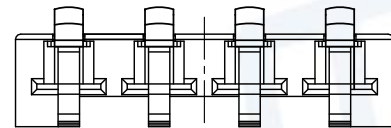
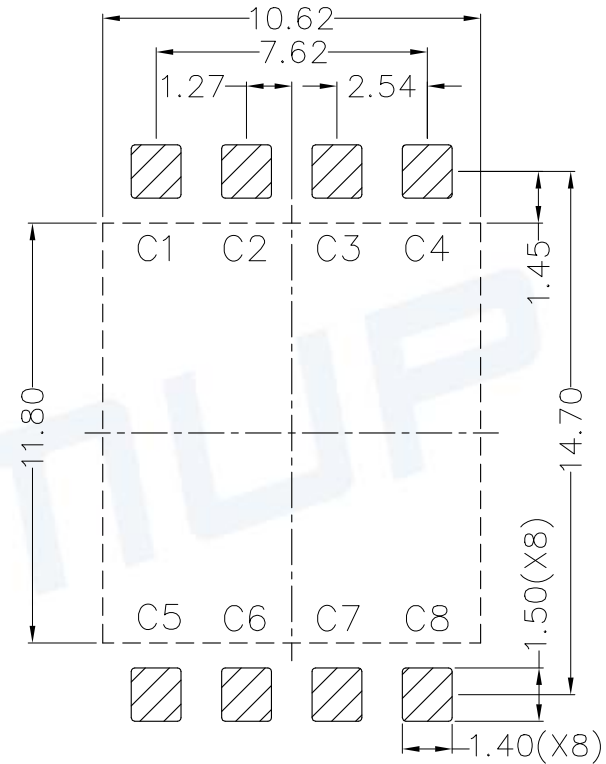


SECTION A-A



| REV. | DESCRIPTION OF REVISIONS | APPR. | DRAW. | RELEASE | DATE |
|------|--------------------------|-------|-------|---------|------|
| X1   |                          |       |       |         |      |
| X2   |                          |       |       |         |      |



RECOMMENDED P.C.B LAYOUT  
COMPONENT SIDE(TOLERANCE ±0.05)

| SIM CARD |          |
|----------|----------|
| Pin No.  | NAME     |
| C1       | VCC      |
| C2       | RST      |
| C3       | CLK      |
| C4       | Reserved |
| C5       | GND      |
| C6       | VPP      |
| C7       | I/O      |
| C8       | Reserved |

TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 11.80LX10.62WXH mm  
H=2.60 mm  
Durability: 5,000 cycles min.

2.Electrical Characteristics

Contact resistance: 50mΩ typical, 100mΩ max  
Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vaporphase: 215°C, 30sec.Max  
IR reflow: 250°C, 5sec.Max  
Manual soldering: 370°C, 3sec.Max

4.Environmental Characteristics

Operating temperature: -40°C~+85°C  
Operating humidity: 10%~+95%RH

| ITEM | PART NAME    | Q'TY | MATERIAL              | FINISH                    |
|------|--------------|------|-----------------------|---------------------------|
| 1    | HOUSING      | 1    | Hi-temp Thermoplastic | Black UL94V-0             |
| 2    | DATA CONTACT | 8    | Copper Alloy          | Contact area: Gold plated |

Unless otherwise specified, other tolerance are:

**MUP** MUP INDUSTRIAL CO.,LTD.

NAME: **SIM Card Connector**

MODEL NO: **MUP C733-3**

TYPE: **H2.6 without post 8p**

|                  |      |       |          |                   |          |                  |
|------------------|------|-------|----------|-------------------|----------|------------------|
| PROJ.            | UNIT | SCALE | DRAWN    | Zoey Dec.07.2009  | DWG NO.: | DWG-MUP-C733-003 |
|                  | mm   | 1:1   | CHECKED  | Jimmy Dec.07.2009 | SHEET    | 1/1              |
| CUSTOMER DRAWING |      |       | APPROVAL | Jun Dec.07.2009   | REVISION | X1               |



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